

PESD5V0S2BT

Low capacitance bi-directional double ESD protection diode in SOT23 package

Rev. 02 — 27 May 2004

Product data sheet

1. Product profile

1.1 General description

Low capacitance bi-directional double ESD protection diode in the small SOT23 plastic package designed to protect 2 data lines from the damage caused by Electro Static Discharge (ESD) and other transients.

1.2 Features

- Bi-directional ESD protection of 2 lines
- Low diode capacitance
- Max. peak pulse power: P_{pp} = 130 W at t_p = 8/20 μs
- Low clamping voltage: V_{CL(R)} = 14 V at I_{pp} = 12 A
- Ultra low leakage current: I_{RM} = 5 nA at V_{RWM} = 5 V
- ESD protection > 30 kV
- IEC 61000-4-2; level 4 (ESD)
- IEC-61000-4-5 (surge); I_{pp} = 12 A at t_p = 8/20 μs.

1.3 Applications

- Cellular handsets and accessories
- Portable electronics
- Computers and peripherals
- Communication systems
- Audio and video equipment.

1.4 Quick reference data

Table 1: Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{RWM}	reverse stand-off voltage		-	5	-	V
C _d	diode capacitance	f = 1 MHz; V _R = 0 V	-	35	-	pF
	number of protected lines		-	2	-	



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2. Pinning information

Table 2:	Discrete Pinning		
Pin	Description	Simplified outline	Symbol
1	cathode 1		
2	cathode 2	3	
3	double cathode		工
		SOT23	2
			sym031

3. Ordering information

Table 3: Orde	Ordering information						
Type number	Package						
	Name	Description	Version				
PESD5V0S2BT	-	plastic surface mounted package; 3 leads	SOT23				

4. Marking

Table 4: Marking	
Type number	Marking code [1]
PESD5V0S2BT	*G5

[1] * = p: made in Hong Kong.

- * = t: made in Malaysia.
- * = W: made in China.

5. Limiting values

Table 5: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
Per diode						
P _{pp}	peak pulse power	8/20 μs pulse	<u>[1][2]</u>	-	130	W
I _{pp}	peak pulse current	8/20 μs pulse	<u>[1][2]</u>	-	12	А
Tj	junction temperature			-	150	°C
T _{amb}	operating ambient temperature			-65	+150	°C
T _{stg}	storage temperature			-65	+150	°C

[1] Non-repetitive current pulse 8/20 μ s exponential decay waveform; see Figure 1.

[2] Measured between pins 1 to 3 or pin 2 to 3.

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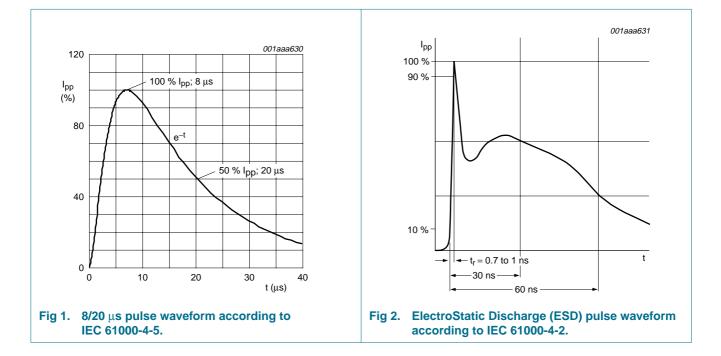
Table 6:	ESD maximum rating	S			
Symbol	Parameter	Conditions		Value	Unit
ESD	electro static discharge capability	IEC 61000-4-2 (contact discharge)	<u>[1][2]</u>	30	kV
		HBM MIL-Std 883		10	kV

[1] Device stressed with ten non-repetitive Electro Static Discharge (ESD) pulses; see Figure 2.

[2] Measured between pins 1 to 3 or pin 2 to 3.

Table 7: ESD standards compliance

Standard	Conditions
IEC 61000-4-2; level 4 (ESD); see Figure 2	> 15 kV (air); > 8 kV (contact)
HBM MIL-Std 883; class 3	> 4 kV



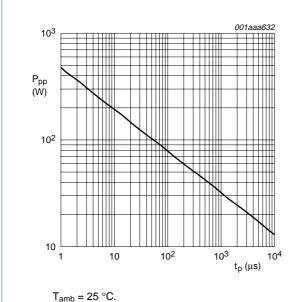
6. Characteristics

Table 8:Electrical characteristics $T_{amb} = 25 \circ C$ unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Per diod	le						
V _{RWM}	reverse stand-off voltage			-	-	5	V
I _{RM}	reverse leakage current	V _{RWM} = 5 V		-	5	100	nA
V _{(CL)R}	clamping voltage	I _{pp} = 1 A	[1] [2]	-	-	10	V
		I _{pp} = 12 A	[1] [2]	-	-	14	V
V _{BR}	breakdown voltage	I _R = 1 mA		5.5	-	9.5	V
r _{diff}	differential resistance	I _R = 1 mA		-	-	50	Ω
C _d	diode capacitance	f = 1 MHz; V _R = 0 V		-	35	45	pF

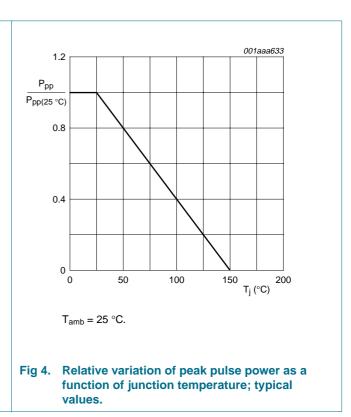
[1] Non-repetitive current pulse 8/20 µs exponential decay waveform, see Figure 3.

[2] Measured from pin 1 to 3 or pin 2 to 3.



 $t_p = 8/20 \ \mu s$ exponential decay waveform; see Figure 1.

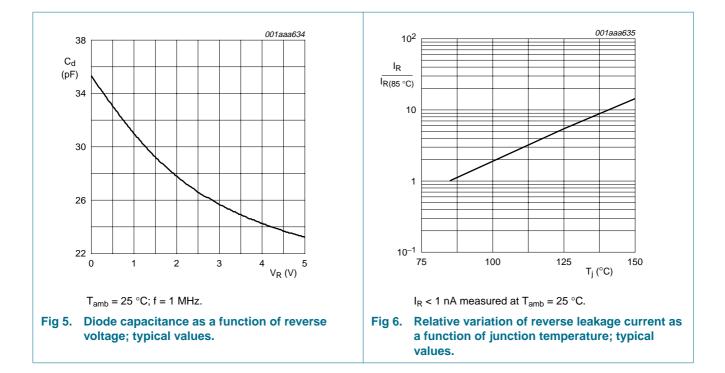
Fig 3. Peak pulse power dissipation as a function of pulse time; typical values.



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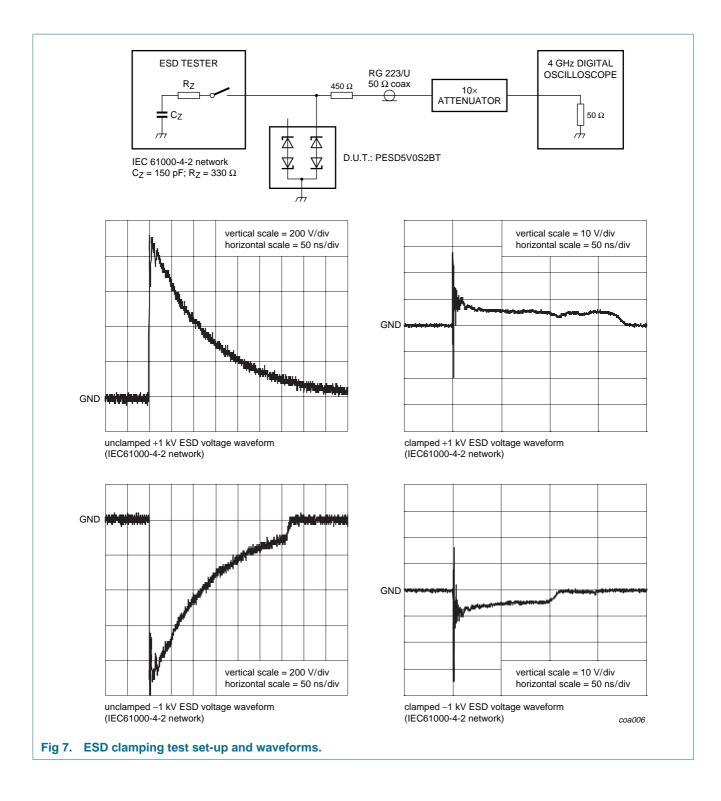
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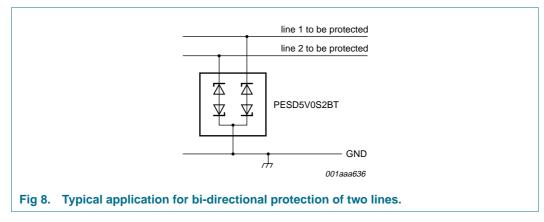
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7. Application information

The PESD5V0S2BT is designed for the bi-directional protection of 2 lines from the damage caused by Electro Static Discharge (ESD) and surge pulses. The PESD5V0S2BT may be used on lines where the signal polarities are above and below ground. The PESD5V0S2BT provides a surge capability of 130 Watts peak P_{pp} per line for an 8/20 μ s waveform.



Circuit board layout and protection device placement:

Circuit board layout is critical for the suppression of ESD, Electrical Fast Transient (EFT) and surge transients. The following guidelines are recommended:

- 1. Place the PESD5V0S2BT as close to the input terminal or connector as possible.
- 2. The path length between the PESD5V0S2BT and the protected line should be minimized.
- 3. Keep parallel signal paths to a minimum.
- 4. Avoid running protected conductors in parallel with unprotected conductors.
- 5. Minimize all printed-circuit board conductive loops including power and group loops.
- 6. Minimize the length of the transient return path to ground.
- 7. Avoid using shared transient return paths to a common ground point.
- 8. Ground planes should be used whenever possible. For multilayer printed-circuit boards, use ground vias.

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8. Package outline

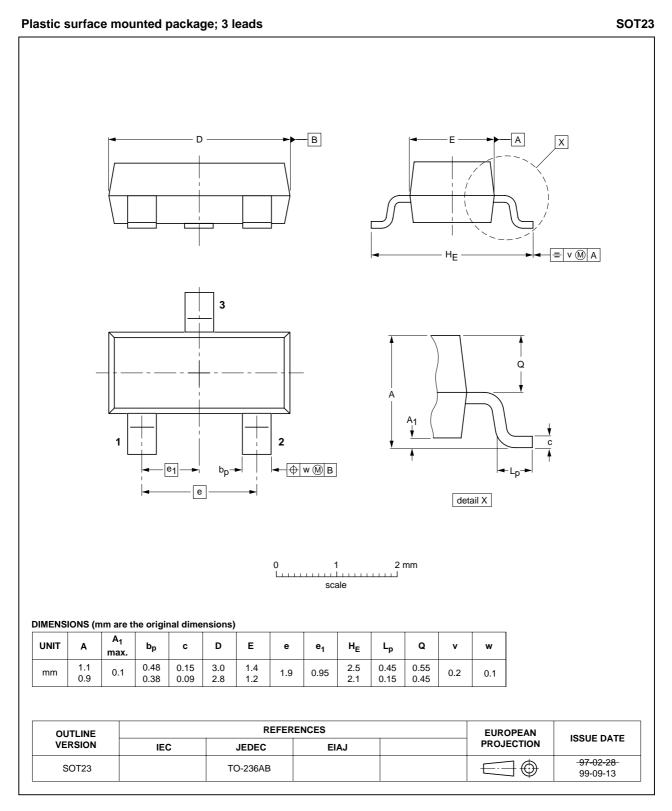


Fig 9. Package outline.

9. Revision history

Table 9: Re	Revision history						
Document ID)	Release date	Data sheet status	Change notice	Order number	Supersedes	
PESD5V0S2E	3T_2	20040527	Product data	-	9397 750 13344	PESD5V0S2BT_1	
PESD5V0S2E	3T_1	20040517	Product data	-	9397 750 12901	-	

10. Data sheet status

Level	Data sheet status [1]	Product status [2] [3]	Definition
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
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[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

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Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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